

Datasheet

Part number(s) AKU340

Package type LGA, bottom port, metal lid

Data sheet revision 1.0

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Notes Specifications are subject to change without notice.

Product photos and pictures are for illustration purposes only and may

differ from the real product's appearance.



Data Sheet

AKU340 Analog Output, MEMS Microphone

Key Features

- Single-ended analog output omni-directional microphone
- Thin, bottom port package
- High SNR: 62 dB
- High sensitivity: -38 dBV/Pa
- Tight sensitivity tolerance: +/- 2 dBV/Pa
- Flat frequency response: +/- 3dB 60Hz 12.5kHz
- High PSR: -62 dBV
- Metal package immune to RF/EM interference
- Small form factor: 2.5 x 3.35 x 1.00 mm
- Lead-free, RoHS compliant, and Halogen Free in accordance with IEC61249-2-21

Typical Applications

- Smartphones & Mobile handsets
- Tablet computers
- Speaker phones
- Digital still/video cameras
- · Bluetooth & wired headsets
- Portable media players

General Description

The AKU340 is a surface-mountable analog-output MEMS microphone offered in a space saving bottom port metal lid package of 2.5 x 3.35 x 1.00 mm. Designed specifically to meet the demanding requirements of mobile handset OEMs, the AKU340 offers excellent acoustic performance with 62dB signal-to-noise ratio (SNR) and a flat wideband frequency response, with deviations less than +/-3dB from 60Hz to 12.5kHz, delivering uniform audio capture across a broad acoustic spectrum. In addition, with its tight sensitivity matching of just +/-2dB between microphones, the AKU340 is ideal for use in microphone array applications where more uniform microphones lead to increased performance of noise suppression algorithms.



Data Sheet

Index of Contents

1. ABSOLUTE MAXIMUM RATINGS	4
2. STANDARD OPERATING CONDITIONS	4
3. ELECTRICAL AND ELECTRO-ACOUSTIC SPECIFICATIONS	4
4. DEVICE CHARACTERISTICS	5
 4.1 Typical Frequency Response 4.2 I_{DD} vs. V_{DD} 4.3 Sensitivity vs. V_{DD} 4.4 Total Harmonic Distortion 	
5. PACKAGE	6
6. PIN-OUT AND CONNECTION DIAGRAMS	7
6.1 Pin Out 6.2 Schematic	
7. MANUFACTURING NOTES	8-10
7.1 Solder Reflow 7.2 Part Handling 7.3 PCB Land Pattern & Stencil Pattern	
8. RELIABILITY SPECIFICATIONS	11
9. PART MARKING INFORMATION	11
10. PACKAGING INFORMATION	12
11. ORDERING INFORMATION	12
12. REFERENCE MATERIALS	13-14
12.1 Application Notes 12.2 Theory of Operation 12.3 Measurement Guidelines 12.4 Glossary of Terms	



Data Sheet

1. ABSOLUTE MAXIMUM RATINGS

Supply Voltage, V_{DD} to GND 5.5V

ESD Tolerance

Human Body Model 2000V Machine Model 200V

Storage Temperature Range -40°C to 105°C

2. STANDARD OPERATING CONDITIONS

Operating Temperature Range @ 2V -40° C to 85°C Supply Voltage (V_{DD}) -40° C to 3.6V

3. ELECTRICAL AND ELECTRO-ACOUSTIC SPECIFICATIONS

Unless otherwise noted, test conditions are: V_{DD} = 2.0V Ta = 25°C RH = 50%

Parameter	Test Conditions		Тур.	Max.	Unit	
Directivity		Omni-directional				
2	Low Frequency -3dB point		60		Hz	
Frequency Response ²	Upper Frequency +3dB point		12.5		kHz	
Signal to Noise Ratio (SNR)	f _{in} =1 kHz, A-weighted, 20Hz- 10kHz, 0dB gain		62		dB	
Sensitivity ¹	1kHz, 94 dB SPL	-40	-38	-36	dBV/Pa	
Total Harmonic Distortion (THD) ¹	@ 94dB SPL, f _{in} =1 kHz			0.5	0/	
	@ 114dB SPL, f _{in} =1 kHz			5	%	
Power Supply Rejection Ratio (PSRR)	100mVpp, f=217Hz	60			dB	
Current Consumption ¹	No load			300	μΑ	
Output Impedance			150		Ω	
Sensitivity loss across voltage	Change in sensitivity over 3.6 to 1.65v		0		dB	
Polarity	Increasing sound pressure	Increasing output voltage				

Note 1: Parameter 100% tested

Note 2: See figure 4.1

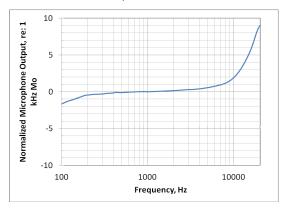


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4. DEVICE CHARACTERISTICS

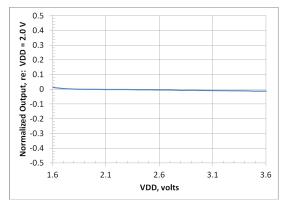
4.1 Frequency Response

(Measured frequency response normalized to 1kHz)



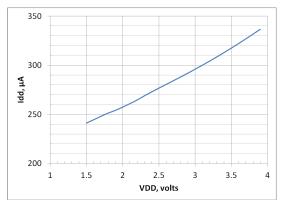
4.3 Sensitivity vs. VDD

(Measured sensitivity changes relative to supply voltage)



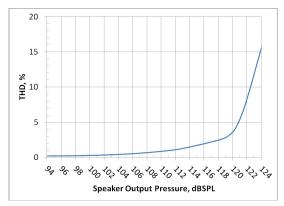
4.2 I_{DD} vs. V_{DD}

(Measured current consumption relative to supply voltage)



4.4 Total Harmonic Distortion

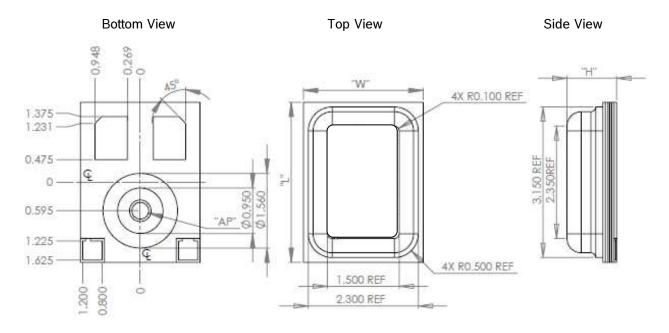
(Measured THD relative to speaker output pressure level)





Data Sheet

5. PACKAGE



Item	Dimension	Tolerance	Units
Length (L)	3.35	± 0.10	mm
Width (W)	2.50	± 0.10	mm
Height (H)	1.00	± 0.10	mm
Acoustic Port (AP)	0.35	± 0.05	mm
Planarity	Top/Bottom	± 0.05	mm

All dimensions in mm
Tolerance ± 0.05mm unless otherwise specified



Data Sheet

6. PIN-OUT AND CONNECTION DIAGRAMS

6.1 Pin-Out

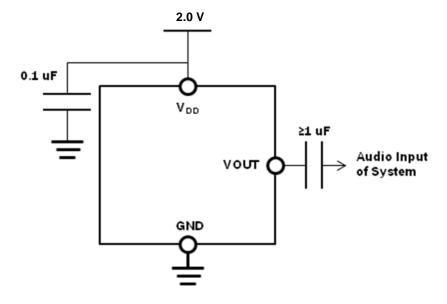
(As viewed from bottom of package)



Pin	Name	Function		
1	V _{OUT}	Analog output voltage		
2	GND	Ground		
3	V_{DD}	Power supply voltage for microphone		
4	NC ¹	No Connect		
5	NC ¹	No Connect		

Note 1: Pins 4 & 5 can be connected to improve reflow manufacturability, but are not necessary. If used, Pins 4 & 5 should be tied to GROUND.

6.2 Typical Application Schematic



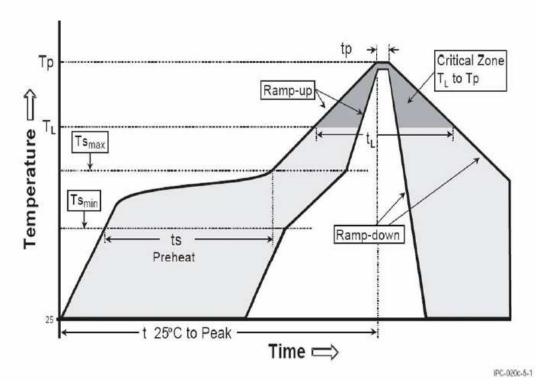


Data Sheet

7. MANUFACTURING NOTES

7.1. Solder Reflow

Typical solder reflow profile



Average ramp-up rate	Max. 3° C/s
Time t _s between Ts _{min} (150° C)and Ts _{max} ° C	60 – 120 s
Time t _L above liquidous temperature T _L (217° C)	60 – 90 s
Peak temperature T _P	max. 260° C
Time t _P at T _P	max. 20 s
Average ramp-down rate	max. 6° C/s

Please refer to AN60-Handling, Soldering, and Mounting Instructions for more detailed information and precautions.



Data Sheet

7.2. Microphone Handling

Although the microphone may not appear damaged immediately due to inappropriate handling, there can be long term effects that affect the lifetime of the component.

Rule of thumb: The microphone is an artificial ear so treat it like your own ear.

- Do not blow air into the acoustic port of the microphone for any reason. Do not shoot it with pressurized air
 - e.g. when cleaning the board or other components on the same board
- Do not apply vacuum to the microphone
 - Pick & place, see 5.3 below
- Do not insert liquids
 - If populated circuit boards are washed, the microphone must be protected
- Do not insert dust
 - The production facilities must be clean
 - e.g. if PCB routing/sawing is done close to the microphone after SMT assembly and reflow
- Do not insert any objects
 - If assembly or rework is done manually, care must be taken that the tools cannot enter the mic sound port
 - It is best to choose tool size so that it does not fit through the sound port of the microphone
- Do not cover the acoustic port with tape when heating during assembly or reflow
- Do not apply extreme mechanical stresses on the microphone, including mechanical shocks above 10kG or compression of the microphone package.
- After a bottom port microphone has been assembled on a circuit board, protect the sound port (now on the other side of the board) from dust, liquids, and other foreign materials as well as any tools and pressurized air.

ESD Handling Procedures



Follow CMOS handling procedures with Akustica MEMS microphones. Handle the microphone with proper workplace grounding to include wrist straps and ionized airflow over open trays and reels of microphones. Do not hot-swap/hot-plug during testing. Device pins have ESD ratings of 2kV/200V for HBM/MM respectively.

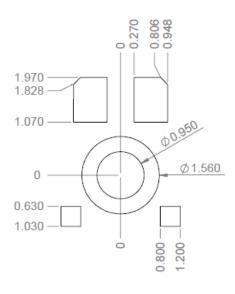


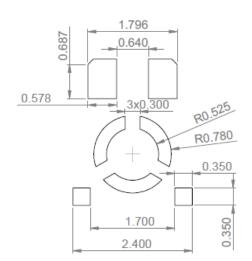
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7.3 PCB Land Pattern & Stencil Pattern

PCB Land Pattern Layout

Suggested solder Paste Stencil Pattern Layout





Please refer to AN60-Handling, Soldering, and Mounting Instructions for more detailed information and precautions.



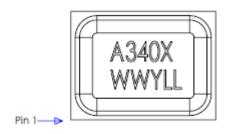
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8. RELIABILITY SPECIFICATIONS

The microphone sensitivity after stress must deviate by no more than 3 dB from the initial value.

	Test	Test Condition	
1	Cold Temp Operation	Temperature = -40C, 1000 hours (with bias)	
2	Hot Temp Operation	Temperature = 105C, 1000 hours (with bias)	
3	Humidity Operation	Temperature = 85C, RH = 85%, 1000 hours (with bias)	
4	Cold Temp Storage	Temperature = -40C, 1000 hours (without bias)	
5	5 Hot Temp Storage Temperature = 105C, 1000 hours (without bias)		
6	Humidity Storage	Temperature = 85C, RH = 85%, 1000 hours (without bias)	
7	Thermal Cycle	100 Cycles, -40 to +125C, 15min soaks, <30sec ramps	
8	8 Vibration Sinusoidal Vibration, 20-2000Hz, 4min sweeps, 16min along eac 3 axis, amplitude 3 limits of 20G and 0.06"		
9	Mechanical Shock	10,000 G shocks, 5 impacts along each of 6 axes	
10	Drop Test	Using 150gm aluminum fixture, 3 drops along each of 6 axes (total 18 drops) from 1.5m height onto concrete drop surface.	
11	ESD (HBM)	+/-2000V, 1 discharge for each polarity, 11 pin combinations, 22 total discharges per microphone	
12	ESD (MM)	+/- 200V, 1 discharge for each polarity, 11 pin combinations, 22 total discharges per microphone	
13	ESD	+/- 8kV, contact discharge to lid with DUT grounded	
14	Moisture Sensitivity Level	24 hour bake at 125C, followed by 168 hours at 85C, 85%RH, followed by 3 passes solder reflow (MSL Level 1)	

9. PART MARKING INFORMATION



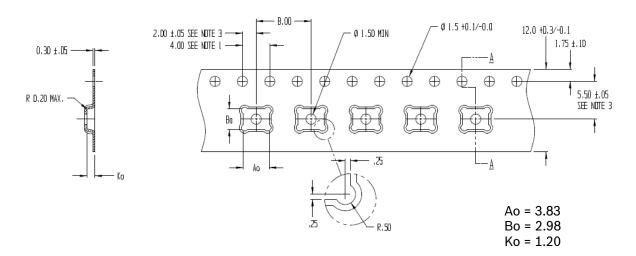
Line 1: A340X (A=Akustica, Part Code=340, X=Assembly Facility) Line 2: WWYLL (WW= Work Week, Y= Year, LL= Lot Number Processed During Work Week)

10. PACKAGING INFORMATION

10.1 Tape Specification



Data Sheet

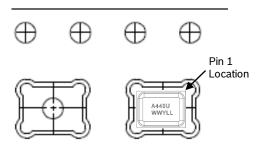


Notes:

- 1. 10 sprocket hole pitch cumulative tolerance +/-0.2
- 2. Camber in compliance with EIA-481
- Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole
- 4. Ao and Bo are calculated on a plane at a distance "R" above the bottom of the pocket

10.2 Component Orientation

5.



11. ORDERING INFORMATION

Part Name	Order Number	Part Code	Package	Shipping Method	Standard Quantity
AKU340	02730A3400	A340	LGA	13" Reel	5,900

For more information, sample requests, or to place an order, please contact Akustica.



Data Sheet

12. REFERENCE MATERIALS

12. 1 Application Notes

AN60 - Handling, Soldering, and Mounting Instructions

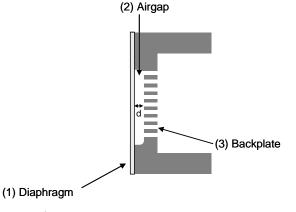
AN48 - AKU340 Coupon Board App Note

12.2 Theory of Operation

The AKU340 analog output microphone is a condenser microphone which has a structure consisting of a diaphragm (1) and a backplate (3), separated by an air gap (2), forming a parallel plate capacitor as shown. The nominal capacitance of the microphone can be determined by $C=\epsilon A/d$ where:

 ε = the permittivity of free space A = area of the diaphragm

d = airgap spacing



Sound pressure impinges on the diaphragm. The deflection of the diaphragm in response to sound causes the capacitance to vary. The variable capacitance is converted into an analog voltage signal which is amplified by the on-chip output amplifier.

12.3 Measurement Information

Measuring Signal to Noise Ratio

The Signal to Noise Ratio (SNR) is the ratio of the output due to a 1 kHz, 94 dB SPL input signal to the Noise Floor of the microphone. It is measured at the output of the on-chip output amplifier. To measure the noise floor, the microphone is placed in a sound isolation box. The power spectral density (PSD) is measured and A-weighted. The A-weighted PSD is integrated over the audio band. The square root of the integrated value is the output Noise Floor of the microphone. Both the SNR and Noise Floor are usually quoted in dB.

12.4 Glossary of Terms

A-weighting: The A-weighting filter is designed to approximate the variation in human ear sensitivity over the audio band at low sound pressure levels and is used to improve the correlation of a measured device noise level to the noise level perceived by the human ear.

dB (Decibel): A decibel (dB) is ten times the logarithm of a power ratio of two quantities. For linear quantities such as pressure and voltage, the decibel level is calculated using the formula dB = 20*log(Value1/Value2). Value1 is usually a measured quantity and Value2 is usually a standard reference quantity that is measurement dependent. In order to calibrate a specification given in dB, you must know the reference value.

Frequency Response: The frequency response indicates the sensitivity of the microphone over a given frequency range.



Data Sheet

12.4 Glossary of Terms (cont.)

Sound Pressure Level (SPL): The sound pressure level is an expression of loudness in dB SPL. The reference value is 20 μ Pa_{rms} which is the lower threshold of hearing of a healthy human ear at 1 kHz. A sound pressure of 1 Pa_{rms} corresponds to a sound pressure level of 94 dB SPL. As a reference, the sound pressure level of a noisy office environment would be roughly 75 dB SPL.

Power Supply Rejection Ratio (PSRR): The PSRR supplies a quantitative measurement of how ripples in the power supply voltage affect the output voltage of a component. It is calculated as the ratio of the power supply voltage change to the output voltage change of the component.

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